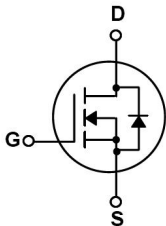


/ Descriptions

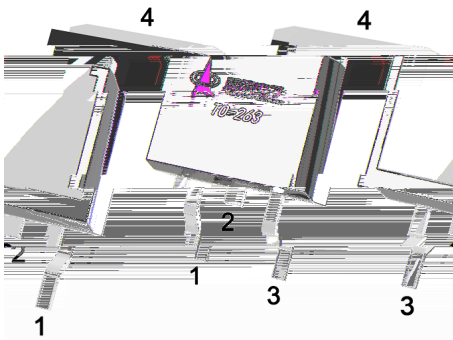
/ Features

/ Applications

/ Equivalent Circuit



/ Pinning



/ Marking

/ Absolute Maximum Ratings(Ta=25)

		℃		
		℃		
	≤	θ		
		θ		

/ Electrical Characteristics(Ta=25)

		μ				
						μ
		μ				
						Ω

/ Electrical Characteristics(Ta=25)

						Ω
		Ω Ω				

/ Electrical Characteristic Curve

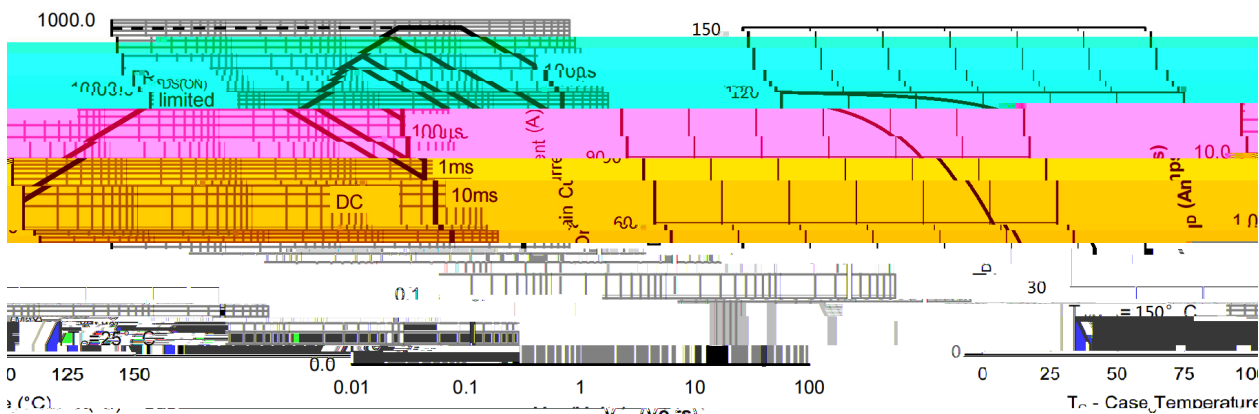
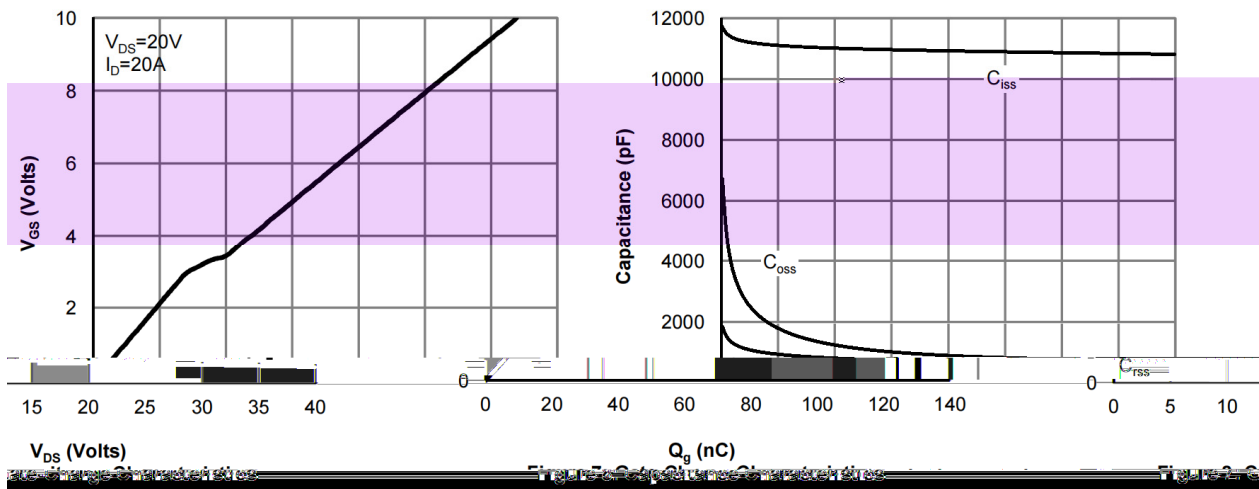


Figure 9: Maximum Forward Biased Safe Operating Area

Figure 10: Maximum C_{oss} vs Case Temperature

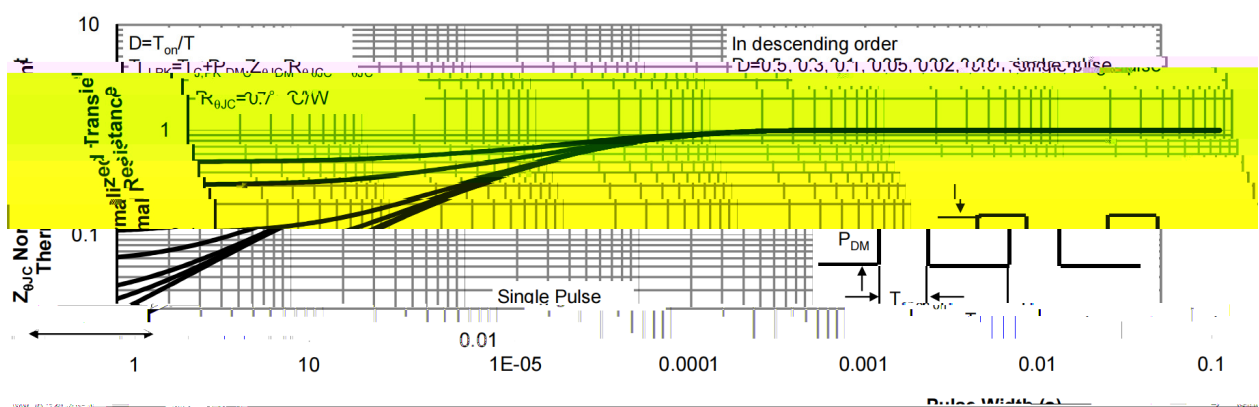
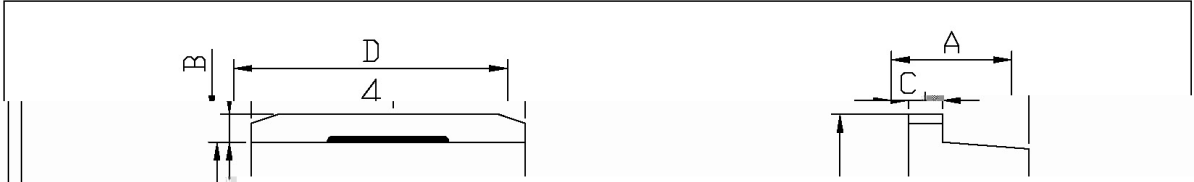


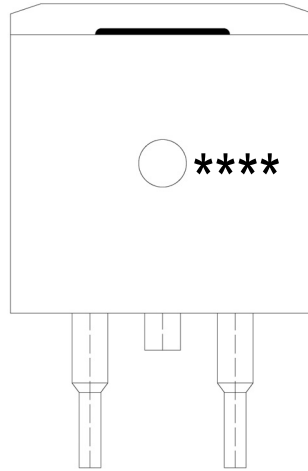
Figure 11: Normalized Maximum Transient Thermal Impedance

/ Package Dimensions

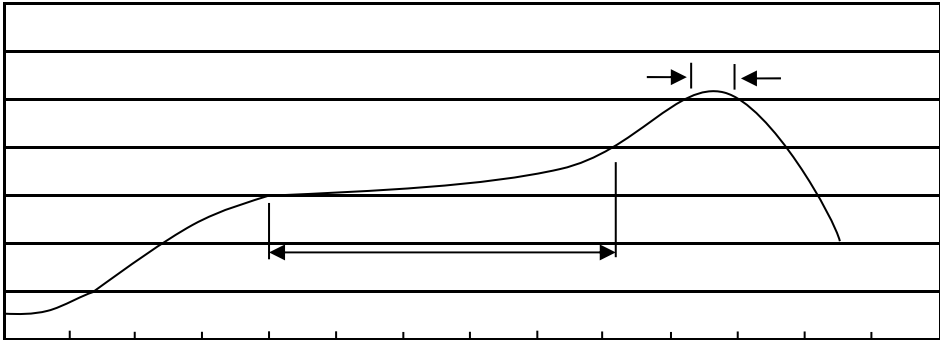


单位: mm							
Symbol		Dimensions In Millimeters		Symbol		Dimensions In Millimeters	
		Min	Max			Min	Max
A		4.30	4.70	E		9.00	9.50
B		1.00	1.40	e1		2.34	2.54
b		0.70	0.90	e2		4.88	5.08
b1		1.15	1.35	J1		1.50	1.60
b2		0.40	0.60	I2		2.24	2.54
C		1.20	1.40	L3		1.20	1.40
D		9.80	10.20				
TP-263							

/ Marking Instructions



() / Temperature Profile for IR Reflow Soldering(Pb-Free)



/ Resistance to Soldering Heat Test Conditions

/ Packaging SPEC.

	Units/Reel /	Reels/Inner Box /	Units/Inner Box /	Inner Boxes/Outer Box /	Units/Outer Box /	Reel	Inner Box	Outer Box
						"		

	Units/Tube /	Tubes/Inner Box /	Units/Inner Box /	Inner Boxes/Outer Box /	Units/Outer Box /	Tube	Inner Box	Outer Box

/ Notices